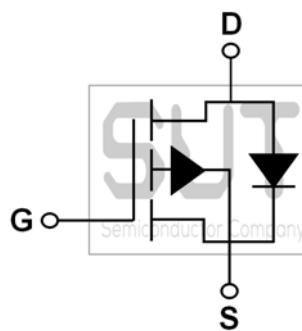
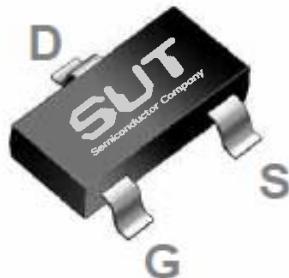


P-Channel 30-V_(D-S) MOSFET

PRODUCT SUMMARY		
B _{VDS} (V)	R _{DS(on)} (mΩ)(MAX)	I _D (A)
-30	50@V _{GS} =-10V	-6.0

SOT23 Pin Configuration



ABSOLUTE MAXIMUM RATINGS(T_C=25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	-30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous (T _C =25°C)	I _D	-6.0	A
Drain Current-Continuous (T _C =100°C)		-4.2	A
Drain Current-Pulsed ¹	I _{DM}	-24	A
Power Dissipation (T _C =25°C)	P _D	1.56	W
Power Dissipation-Derate above 25°C		0.012	W/°C
Storage Temperature Range	T _{STG}	-55 to 150	°C
Operating Junction Temperature Range	T _J	-55 to 150	°C

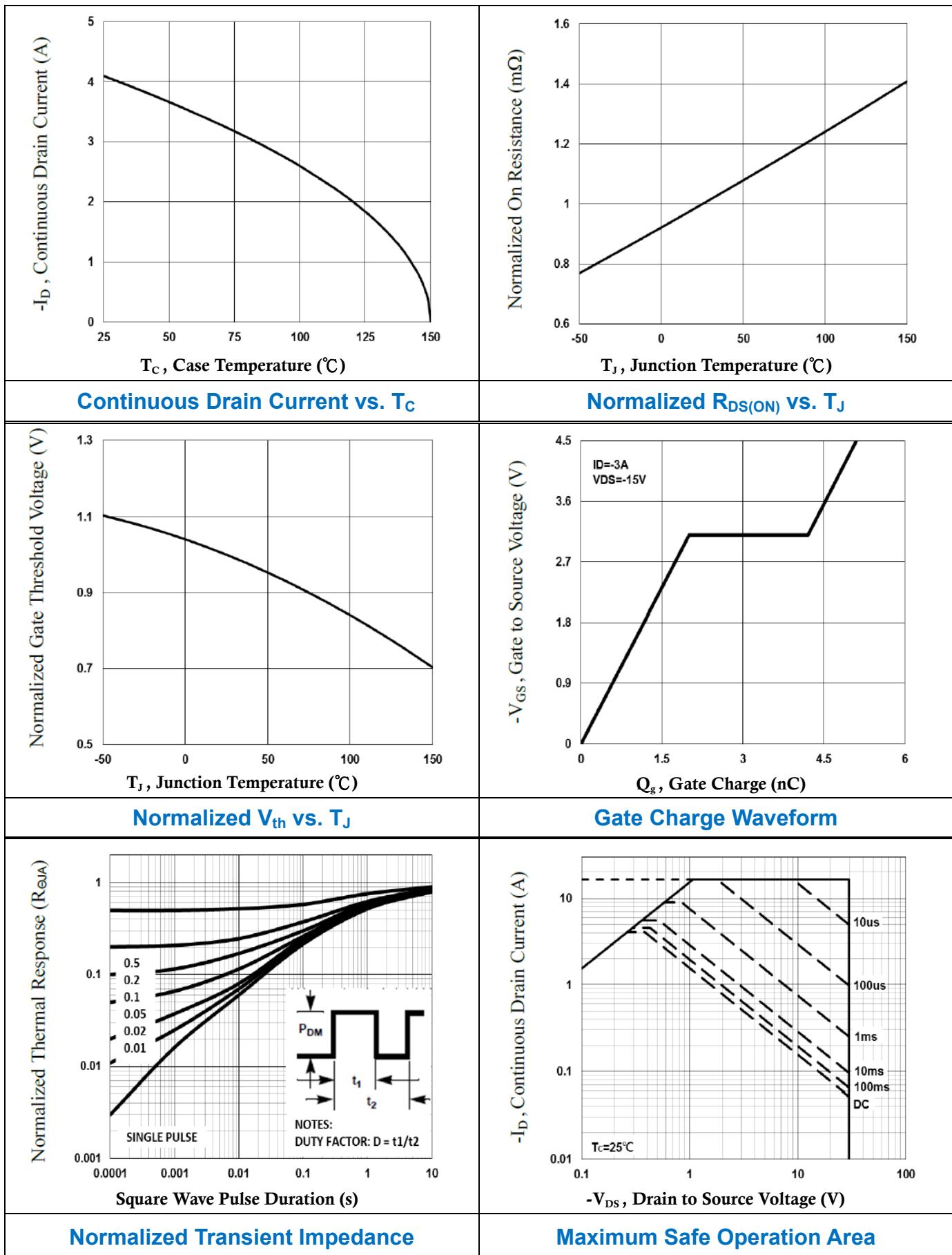
THERMAL CHARACTERISTICS

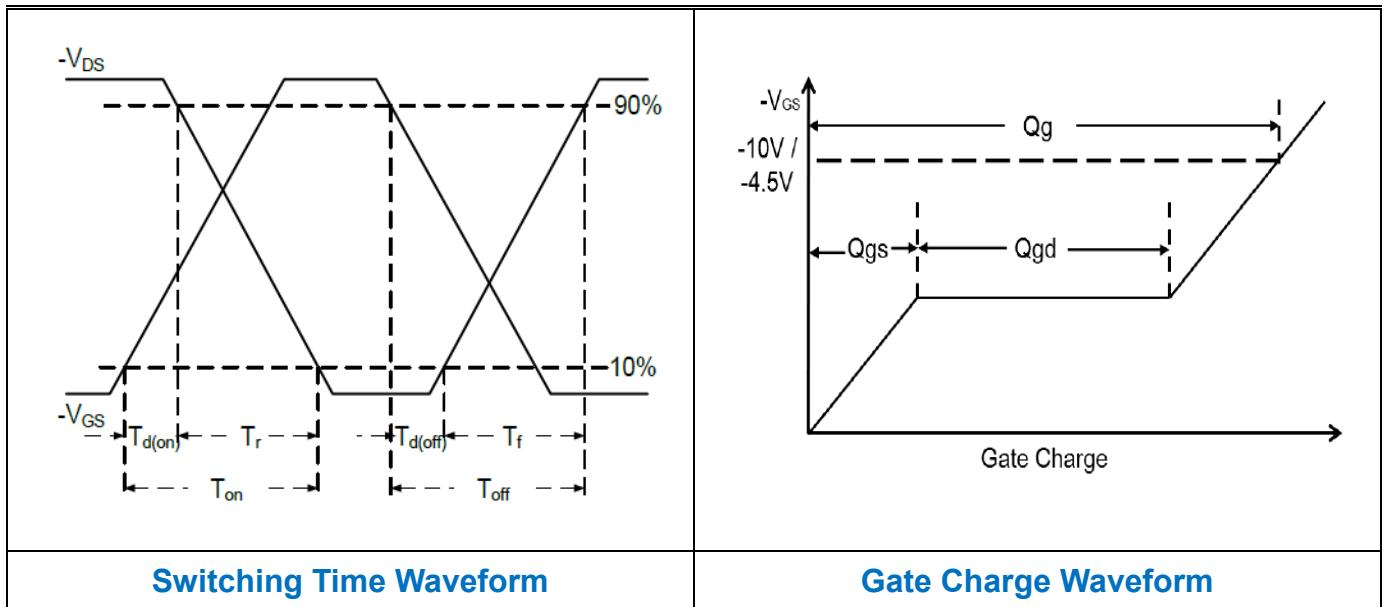
Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	R _{θJA}	---	80	°C/W

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-30	---	---	V
BV_{DSS} Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Reference to 25°C , $I_D=-1\text{mA}$	---	-0.03	---	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-30\text{V}$, $T_J=25^\circ\text{C}$	---	---	-1	μA
		$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-24\text{V}$, $T_J=125^\circ\text{C}$	---	---	-10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 12\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
On Characteristics						
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=-10\text{V}$, $I_D=-4.2\text{A}$	---	42	50	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-4.0\text{A}$	---	53	65	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=-250\mu\text{A}$	-1.0	-1.5	-2.0	V
$V_{\text{GS}(\text{th})}$ Temperature Coefficient	$\Delta V_{\text{GS}(\text{th})}$		---	4.0	---	$\text{mV}/^\circ\text{C}$
Forward Transconductance	g_{fs}	$V_{\text{DS}}=-5\text{V}$, $I_D=-35\text{A}$	---	11	---	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{2, 3}	Q_g	$V_{\text{GS}}=-4.5\text{V}$, $V_{\text{DS}}=-15\text{V}$, $I_D=-3\text{A}$	---	5.1	7.0	nC
Gate-Source Charge ^{2, 3}	Q_{gs}		---	2.0	3.0	
Gate-Drain Charge ^{2, 3}	Q_{gd}		---	2.2	4.0	
Turn-On Delay Time ^{2, 3}	$T_{\text{d}(\text{on})}$	$V_{\text{GS}}=-10\text{V}$, $V_{\text{DD}}=-15\text{V}$, $R_G=6\Omega$, $I_D=-1\text{A}$	---	3.4	6.0	ns
Rise Time ^{2, 3}	T_r		---	10.8	21	
Turn-Off Delay Time ^{2, 3}	$T_{\text{d}(\text{off})}$		---	26.9	51	
Fall Time ^{2, 3}	T_f		---	6.9	13	
Input Capacitance	C_{iss}	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=-15\text{V}$, $f=1\text{MHz}$	---	560	810	pF
Output Capacitance	C_{oss}		---	55	80	
Reverse Transfer Capacitance	C_{rss}		---	40	60	
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	$V_G=V_D=0\text{V}$, Force Current	---	---	-5.0	A
Pulsed Source Current	I_{SM}		---	---	-20	A
Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=0\text{V}$, $I_S=-1\text{A}$, $T_J=25^\circ\text{C}$	---	---	-1.0	V

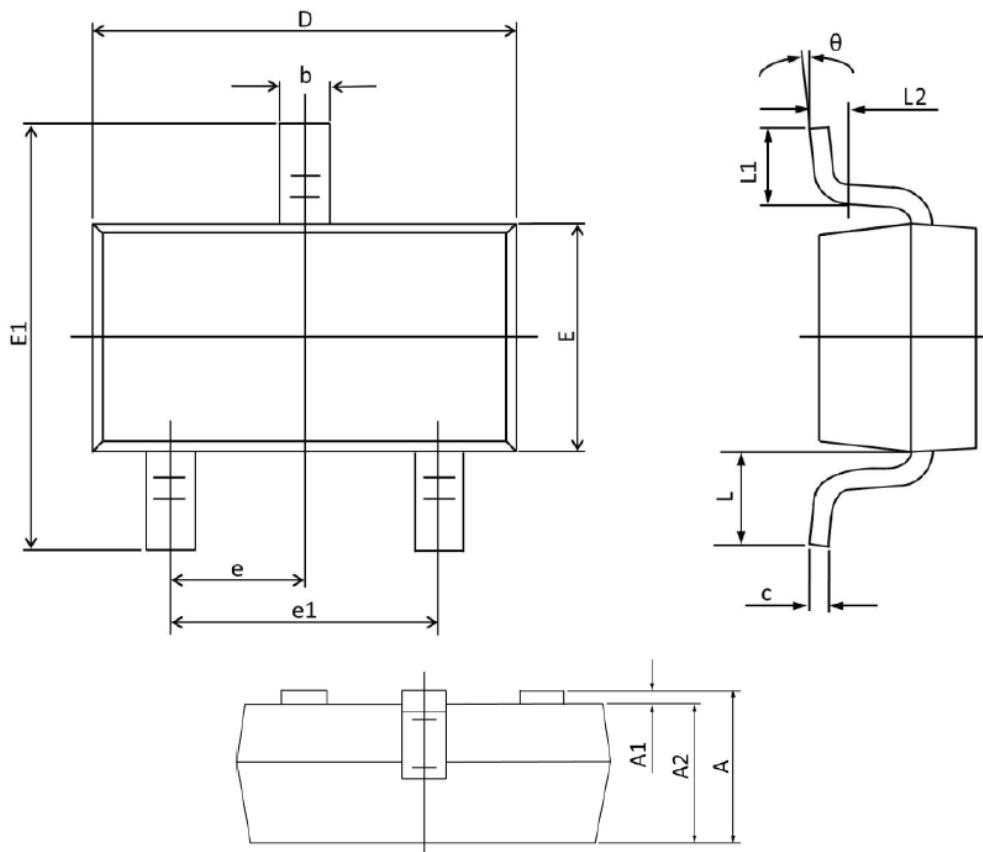
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.





SOT23 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.150	0.900	0.045	0.035
A1	0.100	0.000	0.004	0.000
A2	1.050	0.900	0.041	0.035
b	0.500	0.300	0.020	0.012
c	0.150	0.080	0.006	0.003
D	3.000	2.800	0.118	0.110
E	1.400	1.200	0.055	0.047
E1	2.550	2.250	0.100	0.089
e	0.950(TYP)		0.037(TYP)	
e1	2.000	1.800	0.079	0.071
L	0.550(REF)		0.022(REF)	
L1	0.500	0.300	0.020	0.012
L2	0.250(TYP)		0.010(TYP)	
θ	8°	0°	8°	0°